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Team Nexperia



500 mA low V_F dual MEGA Schottky barrier rectifierRev. 2 — 22 June 2010Product

Product data sheet

1. **Product profile**

1.1 General description

Planar Maximum Efficiency General Application (MEGA) Schottky barrier rectifier in common cathode configuration with an integrated guard ring for stress protection, encapsulated in a SOT23 (TO-236AB) small Surface-Mounted Device (SMD) plastic package.

1.2 Features and benefits

- Average forward current: $I_{F(AV)} \le 0.5 A$ AEC-Q101 qualified
- Reverse voltage: $V_R \le 20 V$
- Low forward voltage

1.3 Applications

- Low voltage rectification
- High efficiency DC-to-DC conversion
- Switch Mode Power Supply (SMPS)

1.4 Quick reference data

Table 1. Quick reference data

 $T_i = 25 \ ^{\circ}C$ unless otherwise specified.

Parameter	Conditions	Min	Тур	Max	Unit
average forward current	square wave; $\delta = 0.5$; f = 20 kHz				
	$T_{amb} \leq 100~^{\circ}C$	<u>[1]</u> _	-	0.5	А
	$T_{sp} \leq 130 \ ^{\circ}C$	-	-	0.5	А
reverse voltage		-	-	20	V
forward voltage	I _F = 0.5 A	-	360	390	mV
reverse current	V _R = 20 V	-	30	200	μA
	reverse voltage forward voltage	$\delta = 0.5; \\ f = 20 \text{ kHz} \\ \hline T_{amb} \le 100 \text{ °C} \\ \hline T_{sp} \le 130 \text{ °C} \\ \hline \hline T_{sp} \le 130 \text{ °C} \\ \hline T_{sp} \ge 130 \text{ °C} \\ \hline T_{sp} = 100 \text{ °C}$	$\begin{split} \delta &= 0.5; \\ f &= 20 \text{ kHz} \\ \hline T_{amb} \leq 100 \text{ °C} & \fbox{1} \text{ -} \\ \hline T_{sp} \leq 130 \text{ °C} & \text{ -} \\ \hline \end{array} \end{split}$ reverse voltage $I_F = 0.5 \text{ A} & \text{ -} \\ \end{split}$	$\label{eq:selectropy} \begin{split} \delta &= 0.5; \\ f &= 20 \text{ kHz} \\ \hline T_{amb} \leq 100 \ ^\circ C \begin{tabular}{ll} - & - & - \\ \hline T_{sp} \leq 130 \ ^\circ C & - & - \\ \hline reverse \ voltage & & - & - \\ \hline forward \ voltage & & I_F = 0.5 \ A & - & 360 \end{split}$	$\label{eq:selectropy} \begin{split} \delta &= 0.5; \\ f &= 20 \text{ kHz} \\ \hline T_{amb} \leq 100 \ ^\circ C \begin{tabular}{c c c c c } \hline T_{amb} \leq 100 \ ^\circ C & \begin{tabular}{c c c c c c c } \hline T_{amb} \leq 100 \ ^\circ C & \begin{tabular}{c c c c c c c } \hline T_{amb} \leq 100 \ ^\circ C & \begin{tabular}{c c c c c c c c } \hline T_{amb} \leq 100 \ ^\circ C & \begin{tabular}{c c c c c c c c c c c c c c c c c c c $

[1] Device mounted on a ceramic Printed-Circuit Board (PCB), Al₂O₃, standard footprint.

- Small SMD plastic package
- Reverse polarity protection
- High-speed switching
- Low power consumption applications

500 mA low V_F dual MEGA Schottky barrier rectifier

2. Pinning information

Table 2.	Pinning		
Pin	Description	Simplified outline	Graphic symbol
1	anode (diode 1)		_
2	anode (diode 2)		3
3	common cathode		
			006aaa438

3. Ordering information

Table 3. Orderin	g information	1	
Type number	Package		
	Name	Description	Version
PMEG2005CT	-	plastic surface-mounted package; 3 leads	SOT23

4. Marking

Table 4. Marking codes	
Type number	Marking code ^[1]
PMEG2005CT	P8*
[1] * = -: made in Hong Kong	

- * = p: made in Hong Kong
- * = t: made in Malaysia
- * = W: made in China

5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
Per diode					
V _R	reverse voltage	T _j = 25 °C	-	20	V
I _{F(AV)}	average forward current	square wave; δ = 0.5; f = 20 kHz			
		$T_{amb} \le 100 \ ^{\circ}C$	<u>[1]</u> -	0.5	А
		$T_{sp} \le 130 \ ^{\circ}C$	-	0.5	А
I _{FRM}	repetitive peak forward current	$\begin{array}{l} t_p \leq 1 \text{ ms}; \\ \delta \leq 0.25 \end{array}$	-	3.9	А
I _{FSM}	non-repetitive peak forward current	square wave; t _p = 8 ms	<u>[2]</u> _	10	A
		The state for each the distance of			

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500 mA low V_F dual MEGA Schottky barrier rectifier

Table 5. Limiting values ...continued

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
Per device; o	one diode loaded				
P_{tot} total power dissipation $T_{amb} \leq$		$T_{amb} \leq 25 ~^{\circ}C$	<u>[3]</u> _	330	mW
			<u>[4]</u> _	400	mW
			<u>[1]</u> _	460	mW
Tj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-55	+150	°C
T _{stg}	storage temperature		-65	+150	°C

[1] Device mounted on a ceramic PCB, Al₂O₃, standard footprint.

[2] $T_j = 25 \ ^{\circ}C$ prior to surge.

[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[4] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

6. Thermal characteristics

Table 6.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per devic	e; one diode loaded					
R _{th(j-a)}	thermal resistance from	in free air	<u>[1]</u>			
	junction to ambient		[2] _	-	375	K/W
			[3] _	-	310	K/W
			<u>[4]</u> _	-	270	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point		<u>[5]</u> _	-	60	K/W

[1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P_R are a significant part of the total power losses.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

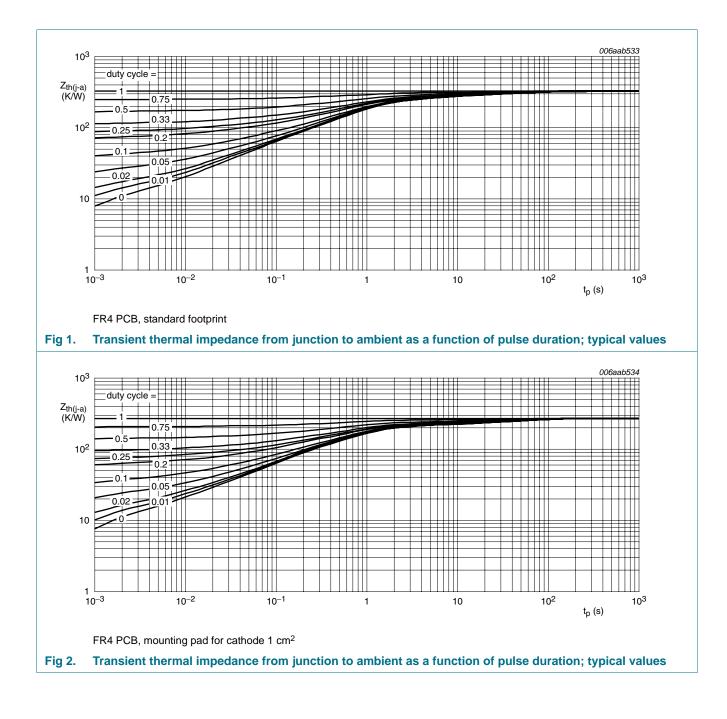
[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

[4] Device mounted on a ceramic PCB, Al_2O_3 , standard footprint.

[5] Soldering point of cathode tab.

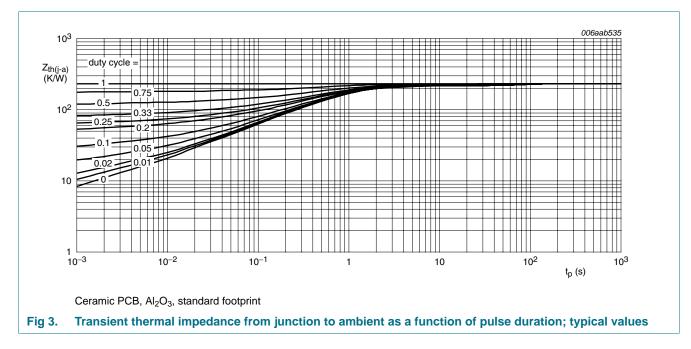
PMEG2005CT

500 mA low V_F dual MEGA Schottky barrier rectifier



PMEG2005CT

500 mA low V_F dual MEGA Schottky barrier rectifier



7. Characteristics

Table 7.Characteristics

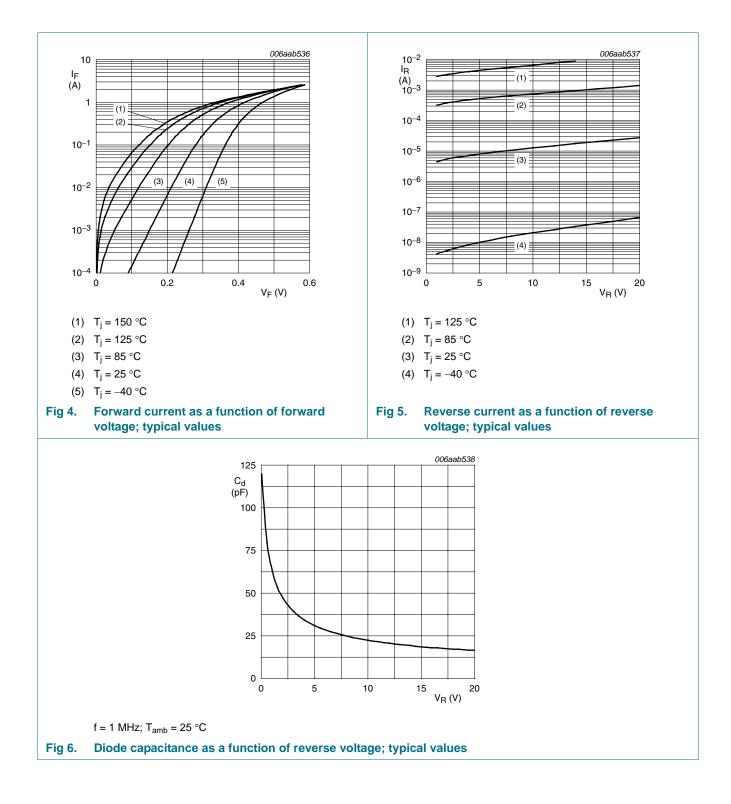
Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
Per device						
V _F	forward voltage	I _F = 0.1 mA	-	95	130	mV
		I _F = 1 mA	-	155	190	mV
		I _F = 10 mA	-	215	240	mV
		I _F = 100 mA	-	285	330	mV
		I _F = 500 mA	-	360	390	mV
I _R	reverse current	V _R = 10 V	-	11	40	μA
		V _R = 20 V	-	30	200	μA
C _d	diode capacitance	$V_R = 1 V$; f = 1 MHz	-	66	80	pF
t _{rr}	reverse recovery time	9	[1] -	22	-	ns

[1] When switched from I_F = 10 mA to I_R = 10 mA; R_L = 100 $\Omega;$ measured at I_R = 1 mA.

PMEG2005CT Product data sheet

PMEG2005CT

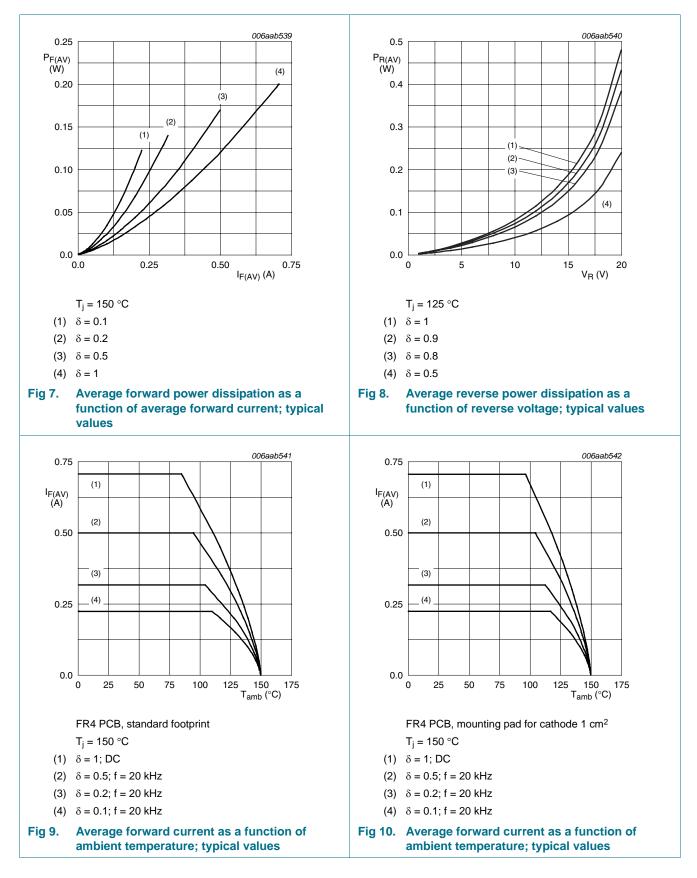
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Product data sheet

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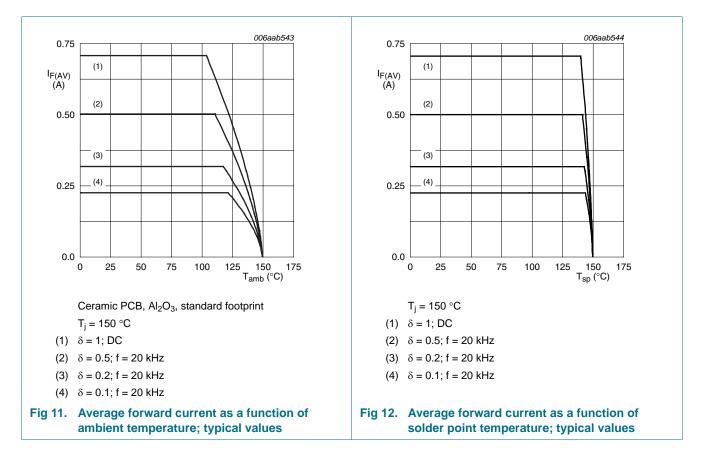
500 mA low V_F dual MEGA Schottky barrier rectifier



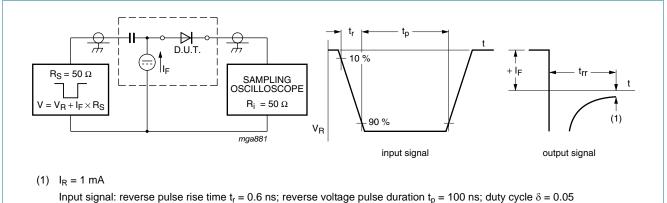
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8. Test information

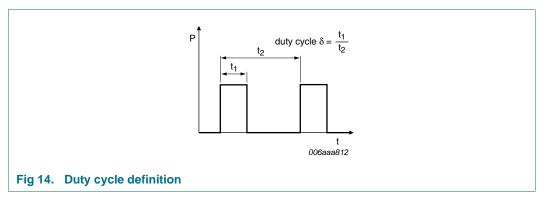


Oscilloscope: rise time $t_r = 0.35$ ns

Fig 13. Reverse recovery time test circuit and waveforms

PMEG2005CT Product data sheet

500 mA low V_F dual MEGA Schottky barrier rectifier

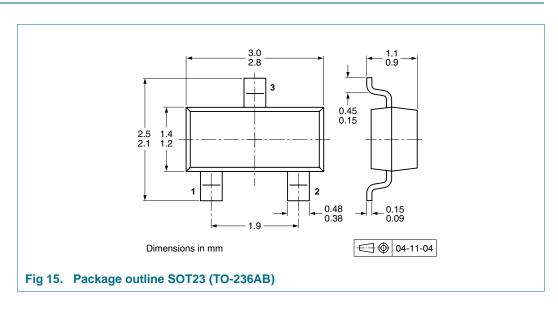


The current ratings for the typical waveforms as shown in Figure 9, 10, 11 and 12 are calculated according to the equations: $I_{F(AV)} = I_M \times \delta$ with I_M defined as peak current, $I_{RMS} = I_{F(AV)}$ at DC, and $I_{RMS} = I_M \times \sqrt{\delta}$ with I_{RMS} defined as RMS current.

8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

9. Package outline



10. Packing information

Table 8. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

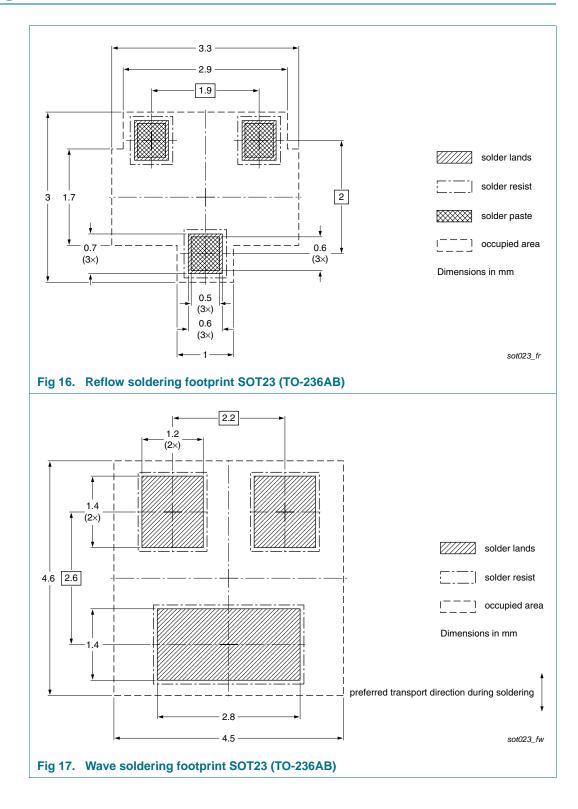
Type number Package		Description	Packing quantity	
			3000	10000
PMEG2005CT	SOT23	4 mm pitch, 8 mm tape and reel	-215	-235

[1] For further information and the availability of packing methods, see <u>Section 14</u>.

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500 mA low V_F dual MEGA Schottky barrier rectifier

11. Soldering



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12. Revision history

Table 9. Revision h	istory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
PMEG2005CT v.2	20100622	Product data sheet	-	PMEG2005CT_1
Modifications:	 Table 2 "Pir 	ning": Graphic symbol am	ended	
	Section 13 '	Legal information": update	ed	
PMEG2005CT_1	20090604	Product data sheet	-	-

500 mA low V_F dual MEGA Schottky barrier rectifier

13. Legal information

13.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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500 mA low V_F dual MEGA Schottky barrier rectifier

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